

Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) An electro-optical device, comprising:
an electro-optical material;
a substrate that supports the electro-optical material;
a first wiring formed over a surface of the substrate;
an insulating layer that covers the first wiring, the insulating layer being formed over the surface of the substrate; and
a second wiring formed over a first region of the insulating layer that includes a region overlapping a region in which the electro-optical material is formed, and a second region which corresponds to a remaining region other than the first region of the insulating layer, the second wiring being connected to the first wiring via a plurality of contact holes formed within the first region of the insulating layer.
2. (Previously Presented) The electro-optical device according to claim 1, further including a counter substrate, the electro-optical material being sandwiched between the substrate and the counter substrate, a sealing material being disposed between the substrate and the counter substrate,
the first region including a region of the insulating layer which faces the sealing material.
3. (Previously Presented) The electro-optical device according to claim 1, the insulating layer further including a mounting region overlaid with an electronic component mounted on the surface of the insulating layer, and the second wiring being connected to the first wiring via a contact hole formed in the mounting region of the insulating layer.

4. (Original) An electro-optical device, comprising:
 - an electro-optical material;
 - a substrate that supports the electro-optical material;
 - a first wiring formed over a surface of the substrate;
 - an insulating layer that covers the first wiring, the insulating layer being formed over the surface of the substrate, and having a mounting region overlaid with an electronic component mounted over the surface of the insulating layer; and
 - a second wiring connected to the electronic component, the second wiring being formed over the surface of the insulating layer, and connected to the first wiring via a contact hole formed within the mounting region.
5. (Previously Presented) The electro-optical device according to claim 3, the electronic component being an integrated circuit that includes an output terminal connected to the second wiring.
6. (Previously Presented) The electro-optical device according to claim 3, the electronic component being a flexible substrate that includes a base having flexibility and a wiring formed on the surface of the base, the wiring being connected to the second wiring.
7. (Previously Presented) The electro-optical device according to claim 1, the first wiring including at least one of an elemental metal and an alloy, and the second wiring including a conductive oxide.
8. (Previously Presented) The electro-optical device according to claim 1, further including a pixel electrode that applies a voltage to the electro-optical material, the second wiring and the pixel electrode being formed of the same layer.
9. (Previously Presented) An electronic apparatus, comprising:
 - the electro-optical device according to claim 1.

10. (New) The electro-optical device according to claim 1, wherein the plurality of contact holes are formed in a line over the first wiring.

11. (New) The electro-optical device according to claim 1, wherein a part of the first wiring is formed overlaid with an electronic component.

12. (New) The electro-optical device according to claim 1, further including a counter substrate and a sealing material between the substrate and the counter substrate, wherein at least one of the plurality of contact holes is formed at a region which faces the sealing material.

13. (New) The electro-optical device according to claim 1, wherein the first wiring is a scanning line.

14. (New) The electro-optical device according to claim 4, wherein the first wiring is a scanning line.